

OSRAM SFH 41847S

Datasheet

Preliminary datasheet version

Published by ams-OSRAM AG

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OSLON® P1616 Lens

SFH 41847S

High Power Infrared Emitter (940 nm)



Applications

- Access Control & Security
- Authentication
- Body Tracking
- Factory Automation
- Home & Building Automation
- Medical Lighting

Features

- Package: clear silicone
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)
- IR lightsource with high efficiency
- Double stack emitter
- Centroid wavelength 940 nm

Ordering Information

Type	Radiant intensity ¹⁾²⁾ $I_F = 1\text{ A}; t_p = 10\text{ ms}$ I_e	Radiant intensity ¹⁾ typ. $I_F = 1\text{ A}; t_p = 10\text{ ms}$ I_e	Ordering Code
SFH 41847S	250 ... 400 mW/sr	310 mW/sr	Q65113A3655

Maximum Ratings

 $T_A = 25\text{ °C}$

Parameter	Symbol		Values
Operating temperature	T_{op}	min. max.	-40 °C 105 °C
Storage temperature	T_{stg}	min. max.	-40 °C 105 °C
Junction temperature	T_j	max.	145 °C
Forward current	I_F	max.	1000 mA
Forward current pulsed $t_p \leq 600\text{ }\mu\text{s}$; $D \leq 0.005$	$I_{F\text{ pulse}}$	max.	2 A
Reverse voltage ³⁾	V_R	max.	5 V
Power consumption	P_{tot}	max.	3300 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	V_{ESD}	max.	2 kV

Note: For the forward current and power consumption please see “maximum permissible forward current” diagram.

Characteristics

 $I_F = 1000 \text{ mA}$; $t_p = 10 \text{ ms}$; $T_A = 25 \text{ °C}$

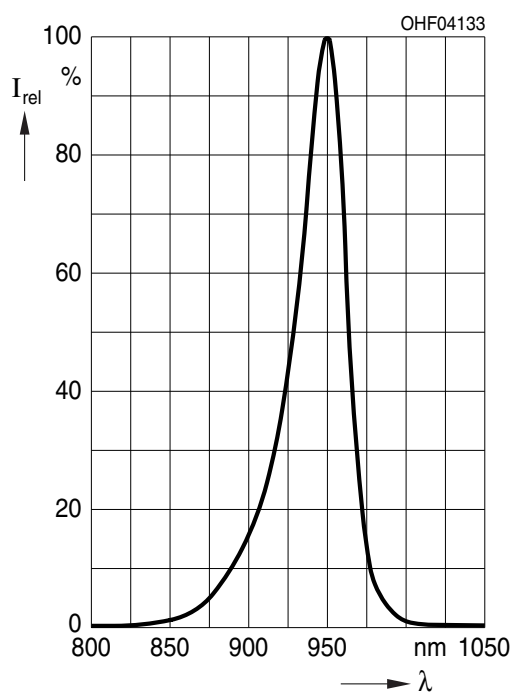
Parameter	Symbol		Values
Peak wavelength	λ_{peak}	typ.	950 nm
Centroid wavelength	$\lambda_{\text{centroid}}$	typ.	940 nm
Spectral bandwidth at 50% $I_{\text{rel,max}}$ (FWHM)	$\Delta\lambda$	typ.	37 nm
Half angle horizontal	φ	typ.	45 °
Half angle vertical	φ	typ.	70 °
Dimensions of chip area	L x W	typ.	0.73 x 0.73 mm x mm
Rise time (10% / 90%) $I_F = 2 \text{ A}$; $R_L = 5 \text{ } \Omega$	t_r	typ.	9 ns
Fall time (10% / 90%) $I_F = 2 \text{ A}$; $R_L = 5 \text{ } \Omega$	t_f	typ.	16 ns
Forward voltage ⁴⁾	V_F	typ. max.	2.95 V 3.20 V
Forward voltage ⁴⁾ $I_F = 2 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	V_F	typ. max.	3.3 V 3.7 V
Reverse current ³⁾	I_R	typ. max.	0.01 μA 10 μA
Total radiant flux ⁵⁾	Φ_e	typ.	1150 mW
Temperature coefficient of voltage	TC_V	typ.	-2 mV / K
Temperature coefficient of brightness	TC_I	typ.	-0.3 % / K
Temperature coefficient of wavelength	TC_λ	typ.	0.3 nm / K
Thermal resistance junction solder point electrical ⁶⁾ with efficiency $\eta_e = 38 \text{ %}$	$R_{\text{thJS elec.}}$	typ. max.	6.8 K / W 8.1 K / W
Thermal resistance junction solder point real ⁶⁾	$R_{\text{thJS real}}$	typ. max.	11.0 K / W 13.0 K / W

Brightness Groups

Group	Radiant intensity ¹⁾²⁾ $I_F = 1 \text{ A}; t_p = 10 \text{ ms}$ min. I_e	Radiant intensity ¹⁾²⁾ $I_F = 1 \text{ A}; t_p = 10 \text{ ms}$ max. I_e
BB2	250 mW/sr	280 mW/sr
CA1	280 mW/sr	320 mW/sr
CA2	320 mW/sr	355 mW/sr
CB1	355 mW/sr	400 mW/sr

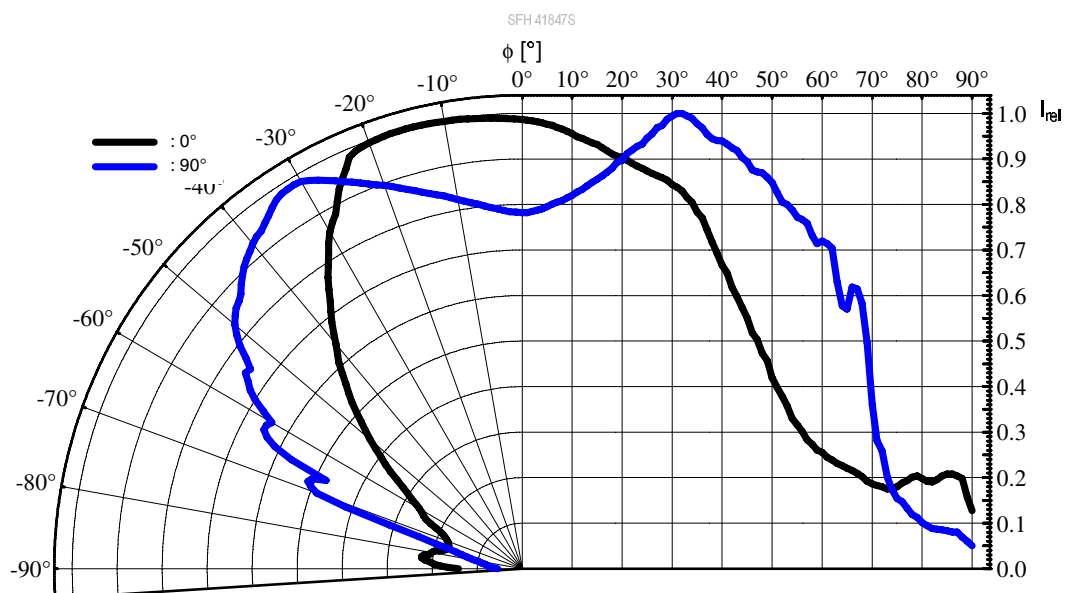
Relative Spectral Emission 7), 8)

$$I_{e,rel} = f(\lambda); I_F = 1000 \text{ mA}; t_p = 10 \text{ ms}$$



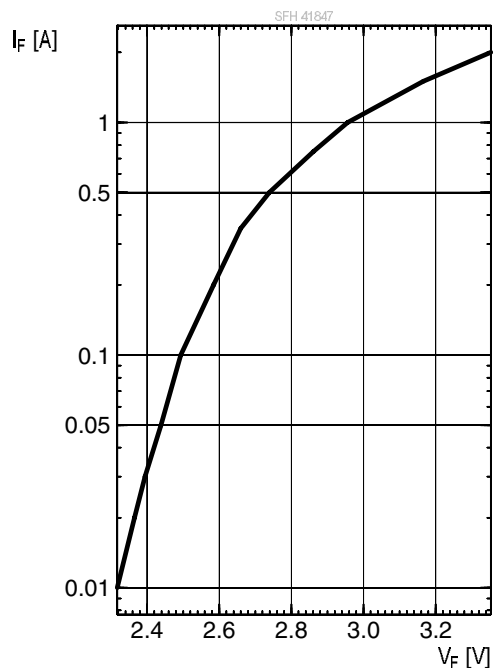
Radiation Characteristics 7), 8)

$$I_{e,rel} = f(\phi)$$



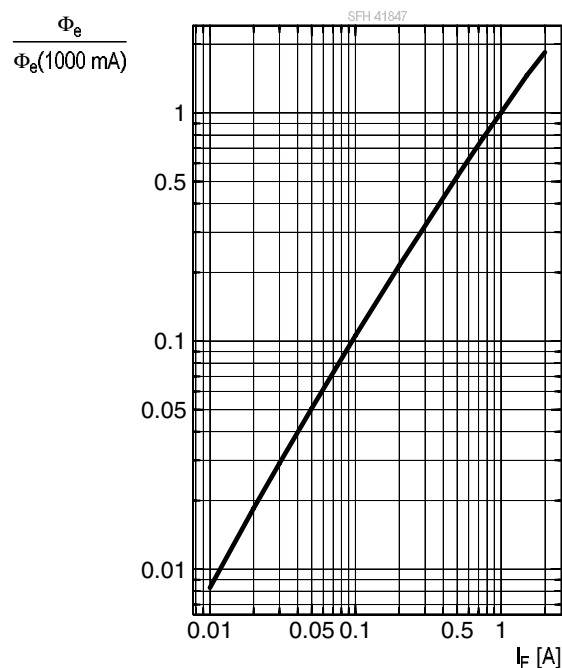
Forward current 7), 8)

$I_F = f(V_F)$; single pulse; $t_p = 100 \mu s$



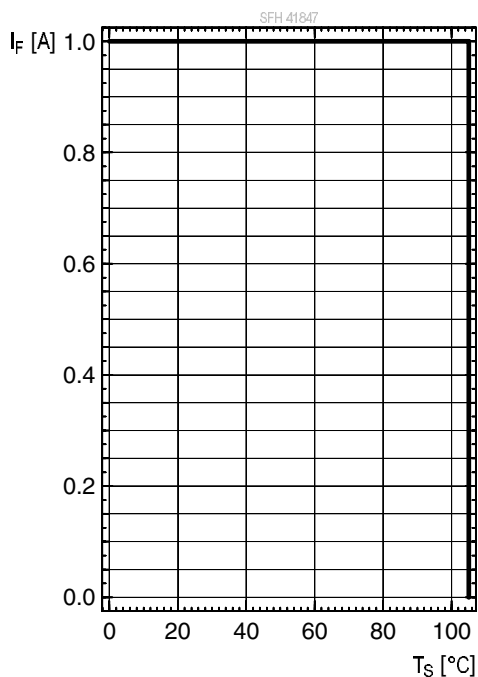
Relative Total Radiant Flux 7), 8)

$\Phi_e / \Phi_e(1000 \text{ mA}) = f(I_F)$; single pulse; $t_p = 100 \mu s$



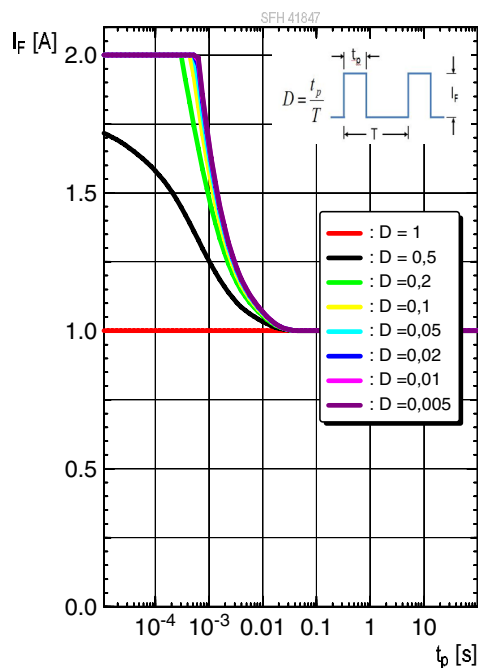
Max. Permissible Forward Current

$I_F = f(T_S)$; $R_{th_{js}} = 13 \text{ K/W}$

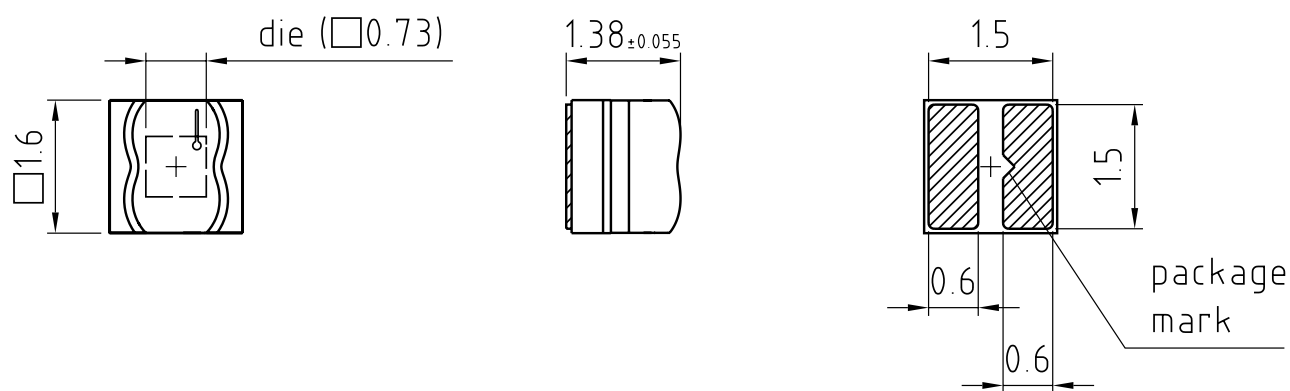


Permissible Pulse Handling Capability

$I_F = f(t_p)$; duty cycle $D = \text{parameter}$; $T_S = 85^\circ \text{C}$



Dimensional Drawing ⁹⁾



general tolerance ± 0.05
lead finish Au 

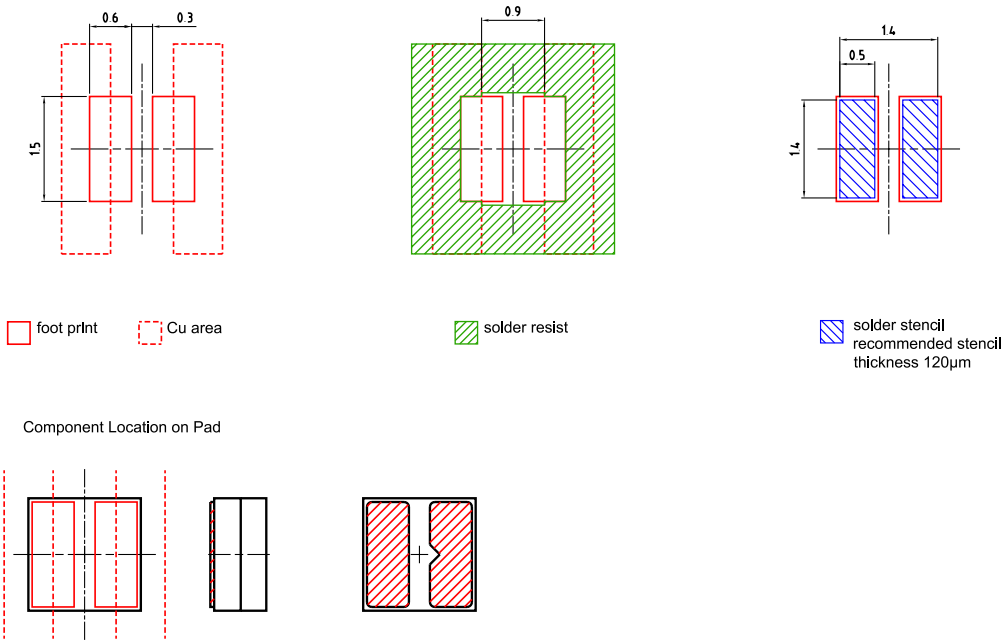
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Further Information:

Approximate Weight: 6.2 mg

Package marking: Cathode

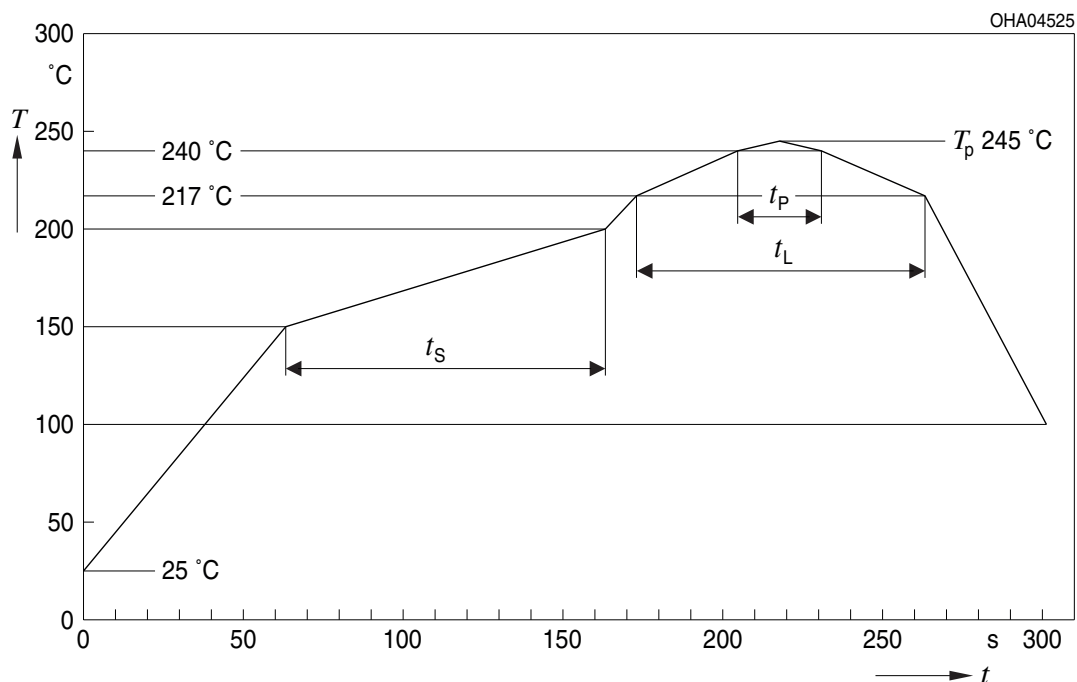
Recommended Solder Pad ⁹⁾



E062 3010.272 -01

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

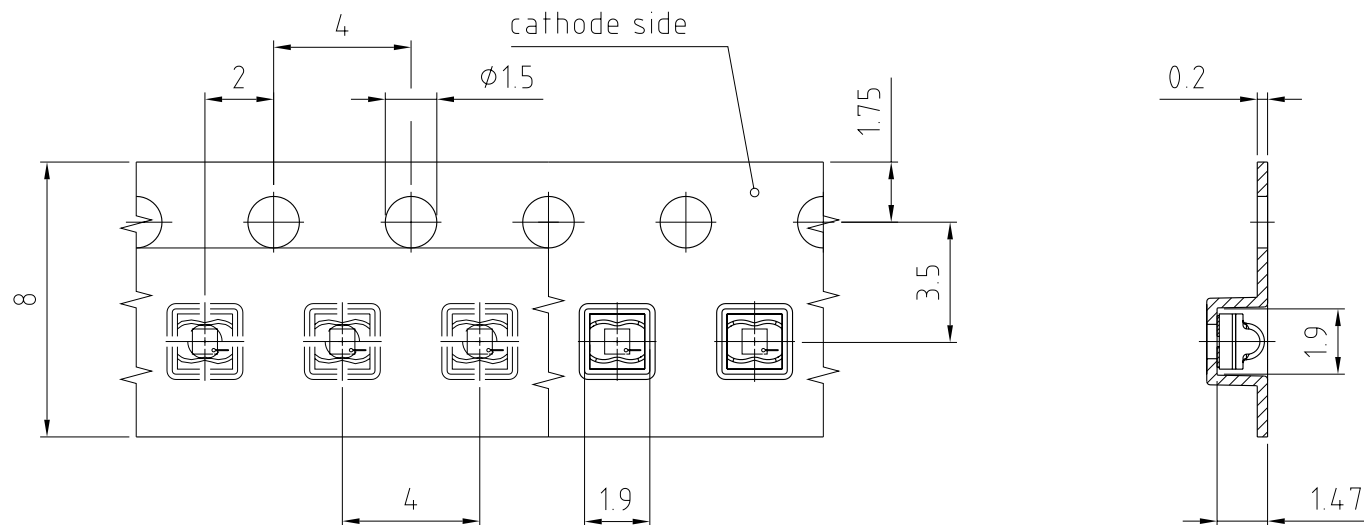


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate*) T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

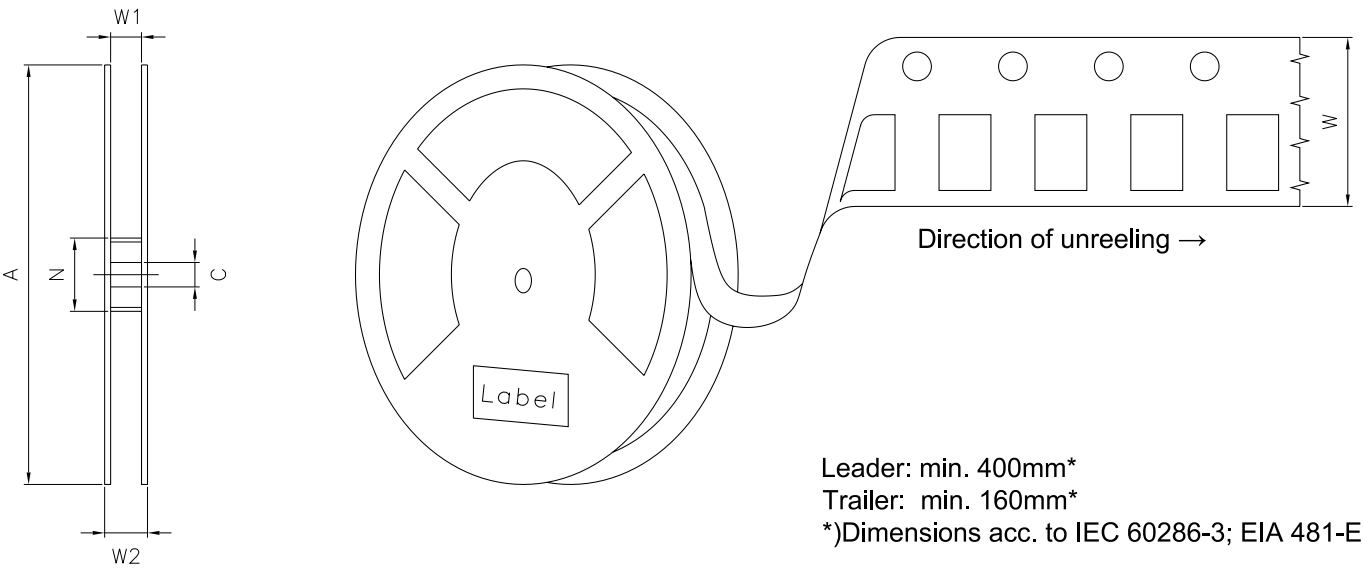
*) slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁹⁾



C63062-A4433-B4-02

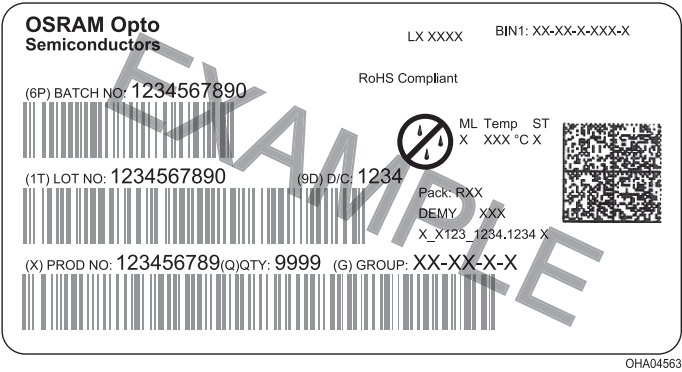
Tape and Reel ¹⁰⁾



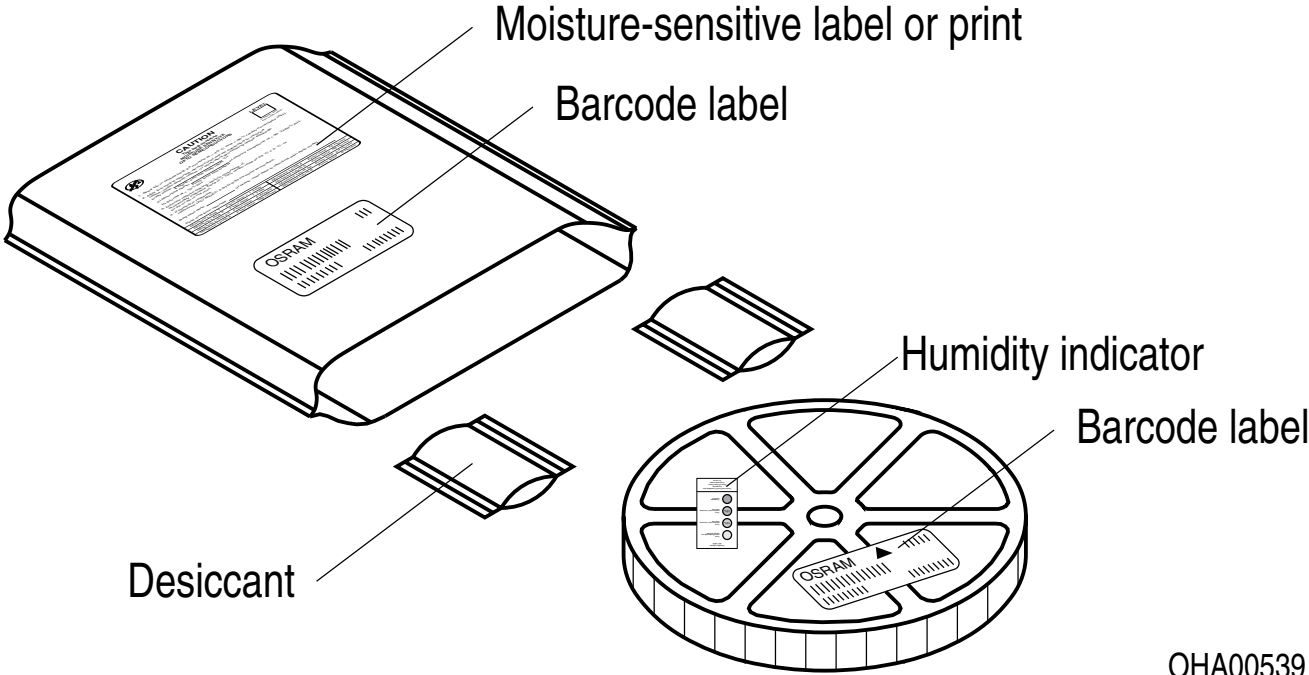
Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	3000

Barcode-Product-Label (BPL)



Dry Packing Process and Materials



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into **exempt risk group - Exempt**.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Handling:

Solvents, water, liquids, non-conductive plastics and glues are not allowed near the device, because solvents and other liquids could emerge and damage the product.

For further application related information please visit www.osram-os.com/appnotes

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Glossary

- 1) **Radiant intensity:** Measured at a solid angle of $\Omega = 0.01$ sr
- 2) **Brightness:** The brightness values are measured with a tolerance of $\pm 11\%$.
- 3) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 4) **Forward Voltage:** The forward voltages are measured with a tolerance of ± 0.1 V.
- 5) **Total radiant flux:** Measured with integrating sphere.
- 6) **Thermal resistance:** junction - soldering point, of the device only, mounted on an ideal heatsink (e.g. metal block)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Testing temperature:** $T_A = 25^\circ\text{C}$ (unless otherwise specified)
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
0.0	2022-10-20	Applications Taping Characteristics

Preliminary datasheet version



EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

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